

Implementation of large Imaging calorimeters

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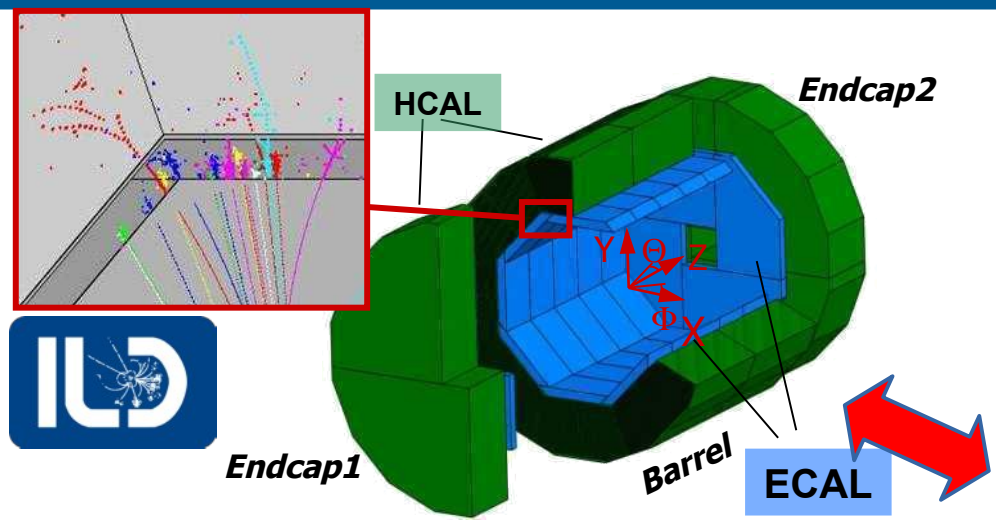
for the  collaboration

ICHEP'2020
30/07/2020, Virtual Prag

LM



Ultra-Granular Calorimeters for Higgs factories: ILD, SiD, CLIC-dp, CEPC-baseline, FCC

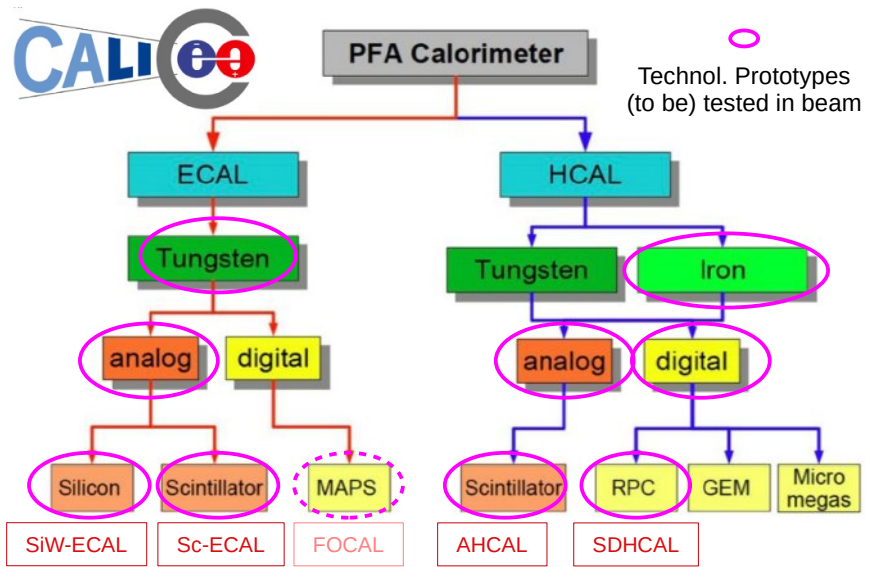


Highly-Granular Calorimeters:

- ECAL @ $R = 150\text{--}180\text{ cm}$, $|Z| = 200\text{ cm}$, Thickness $\sim 25\text{ cm}$
 - cell size = $0.5\text{--}4\text{ cm}$ square (Si) or strip (Sc)
 - 25 – 50 Layers
 - 8 – 70M cells
- HCAL @ ECAL +3 cm, Thickness $\sim 150\text{ cm}$
 - Cell size = $1\text{--}3\text{ cm}$, Gas (RPC) or Sc

Particle Flow optimised calorimetry

- Standard requirements
 - Hermeticity, Resolution, Uniformity & Stability ($E, (\theta, \phi), t$)
- Particle Flow requirements:
 - Extremely high granularity
 - Compactness (density)



Electronics & DAQ

Ωmega ASICs:

- A set of ASICs adapted for all CALICE large scale prototypes
 - Gradual improvement
 - Purely digital DAQ
- adapted to ILC conditions
 - **low power** consumption using **power-pulsing** (~1%)
 - **low noise** pre-amp, dual gain 12-bits ADC, ns TDC
 - **self-trigger** with local storage, **delayed** digitization and **read-out**
 - **high integration** (36–64 channels), daisy **chaining** config and readout

R&D:

- will required update for final ILC integration:
 - full zero-suppression, I2C bus, new technology
 - Improvement of Timing ? Learning from CMS-HGCAL ASIC
- new scheme for circular colliders (power, readout)

~3+ years of dev

Technical requirement on prototypes:

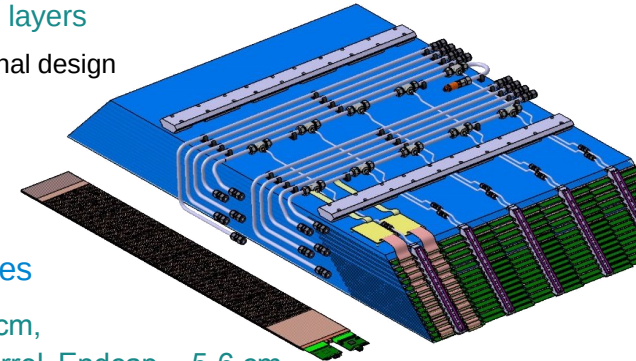
- Integration in cassettes 150 – 300 cm long
 - 12k – 27k cells (200–500 ASICs), power pulsed
 - sensitivity to mip signal (tracking)
 - uniformity, stability, linearity
- **Reproducibility**
 - Typically ~20–50 layers
 - will be ~ 10^4 in final design

DAQ:

- Low power, Small size interfaces
 - ECAL-HCAL = 3 cm, HCAL-Coil or Barrel-Endcap ~ 5-6 cm
- Single side readout

Pulsed Powering in 3–4T field...

- Passive cooling



Validation of prototypes: common goals

Scientific goals:

⇐ many already achieved with physical prototypes
(see next presentation from W. Ootani)

- Energy & Time measurements:
 - Linearity & Resolution to single e, π in 1–200 GeV (\Rightarrow input to jet simulations for PFA)
 - Saturation effects
- 5D Shower profiles
- Particle Flow Algorithm (PFA) tests : shower separation, reconstruction, identification

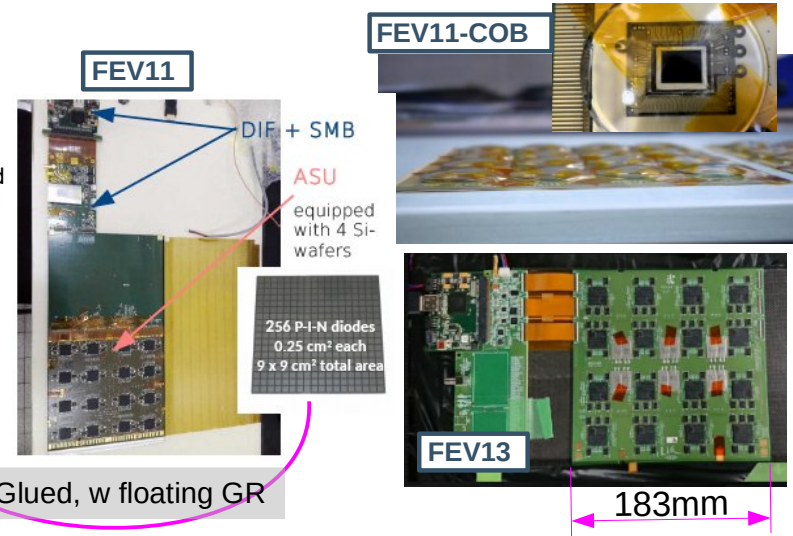
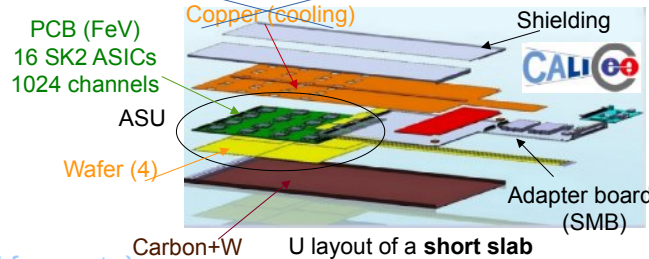
Technical goals:

- Operation of **scalable design** with **power-pulsing**
- **Low-Energy Calibration** with muons (**mips**) position scans, [**High Energy: e, π**]
 - **Signal-to-noise of trigger** (limited memories)
 - **Uniformity**: Efficiency, Mean response (Light Yield, Mip Peak, Multiplicity)
 - Input for **realistic digitization models** \Rightarrow input to simulation: prototype and Particle Flow
- **Scientific goals (again)**: improved granularity, design, etc...
- Running as close as possible to **ILC mode** (200 ns BC), relaxed mode for practical reasons (typ. 4 μ s BC)

Silicon-Tungsten ECAL

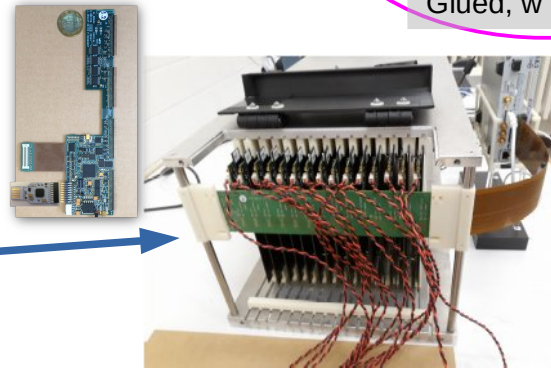
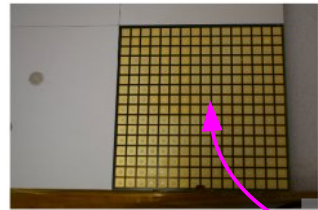
Prototypes for the ILD/ILC

- cells of $\sim 5 \times 5 \text{ mm}^2$, density = 2.6k–3k cell/dm³
- Omega's Skiroc2/2a, 64 ch ASICs
- 25 $\mu\text{W}/\text{ch}$ with 1% Power Cycle (0.3W for proto)

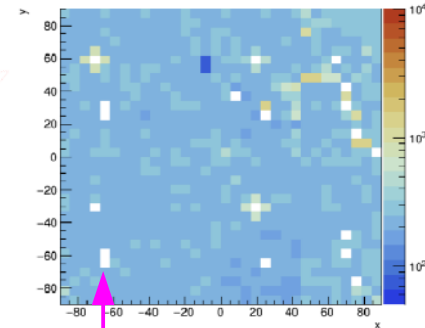
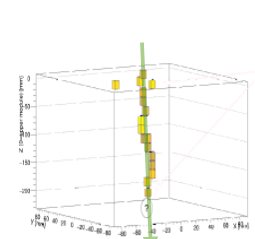


Technological prototype

- “Physical prototype” (2005–11): 10k cells, $\rho = 1.5\text{k cell}/\text{dm}^3$
- $S/N = MPV_{\text{mip}} / \sigma_{\text{Noise}} \geq 10$
- Stacks with **15+7** layers of 1024 ch (15360 cells in a single readout)
 - mix of PCB versions (v10, 11, 12, 13),
 - ⊗ packaged and on-board ASIC's
 - ⊗ 320, 500, 650 μm Silicon wafers
 - New Integrated DAQ, 1st prototype toward ILD-like ($\leq 3\text{cm}$)

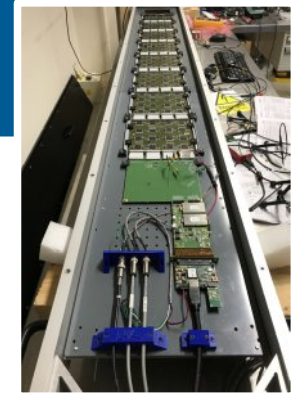


Glued, w floating GR



Noisy cells removed $\sim 1\text{--}3\%$

Silicon-Tungsten ECAL: Developments



Improvement in design

CERN 2015 “naked FEV11” (320 μm)

$S/N_{\text{ADC}} \sim 16\text{--}17$

Ring X-talk / 10 wrt Phys. Proto.

CERN 2017: 7 FEV11 (320 μm)

$S/N_{\text{ADC}} \sim 20.3 \pm 1.5$

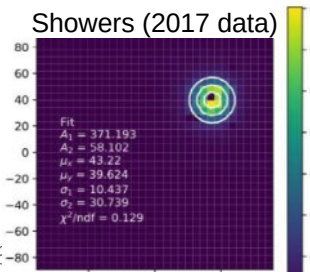
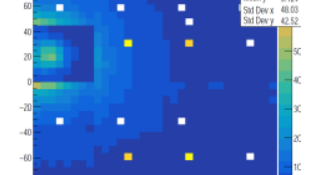
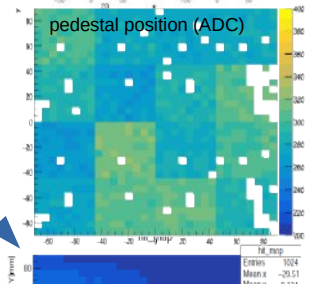
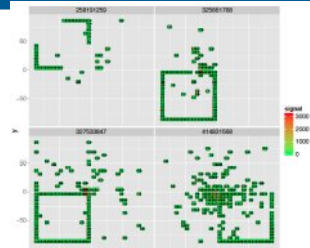
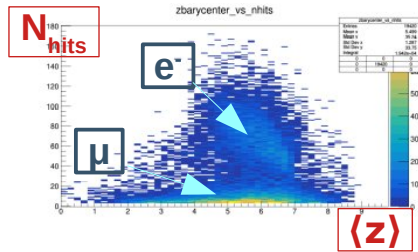
8% masking, 1T operation

DESY 2018: 7 FEV11 + 1 FEV13 (650 μm)

$S/N_{\text{ADC}} \sim 30.3 - 40$;

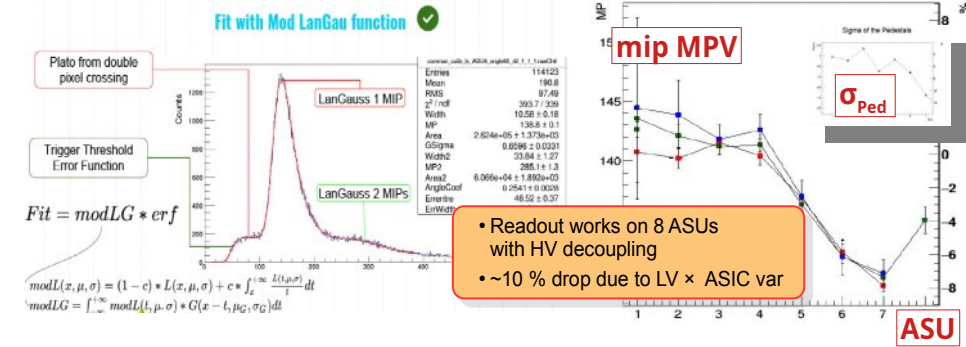
$S/N_{\text{TRIG}} \sim 11.6 \pm 0.7 \Rightarrow \text{Cut} \sim 1/3 \text{ mip} @ 4\sigma$

CERN 2018: 6 FEV11 + 4 FEV13 + 24 $X_0 W$



Long Slab

- 8 ASU's with baby wafers (2x2cm²)



• Readout works on 8 ASUs with HV decoupling
• ~10 % drop due to LV x ASIC var

R&D Highly Resistive Silicon Diodes:

- Ref = Hamamatsu “Guard-Ring-less” design
- 6” Towards 8” (à la CMS-HGCAL) x 725 μm \Rightarrow cost, design, perf.

Ready for physical beam test

March 2020 $\dagger \Rightarrow$ Nov 2020 + 2021

Scintillator-Tungsten ECAL

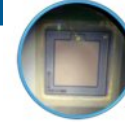
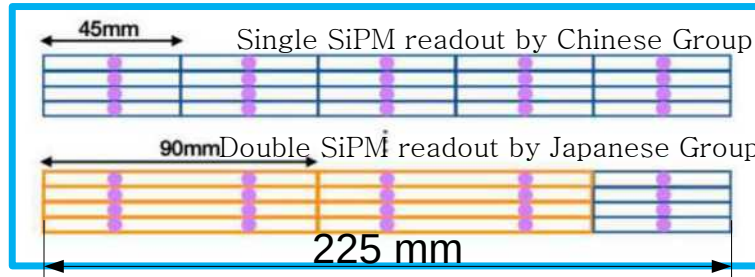
Prototypes for the ILD/ILC & CEPC

- Omega's Spiroc2e, 36 ch ASICs
- 25 $\mu\text{W}/\text{ch}$ with 1% Power Cycle
- cells of $\sim 5 \times 45 \text{ mm}^2$, $\rho = 450 \text{ cell}/\text{dm}^3$

Technological prototype

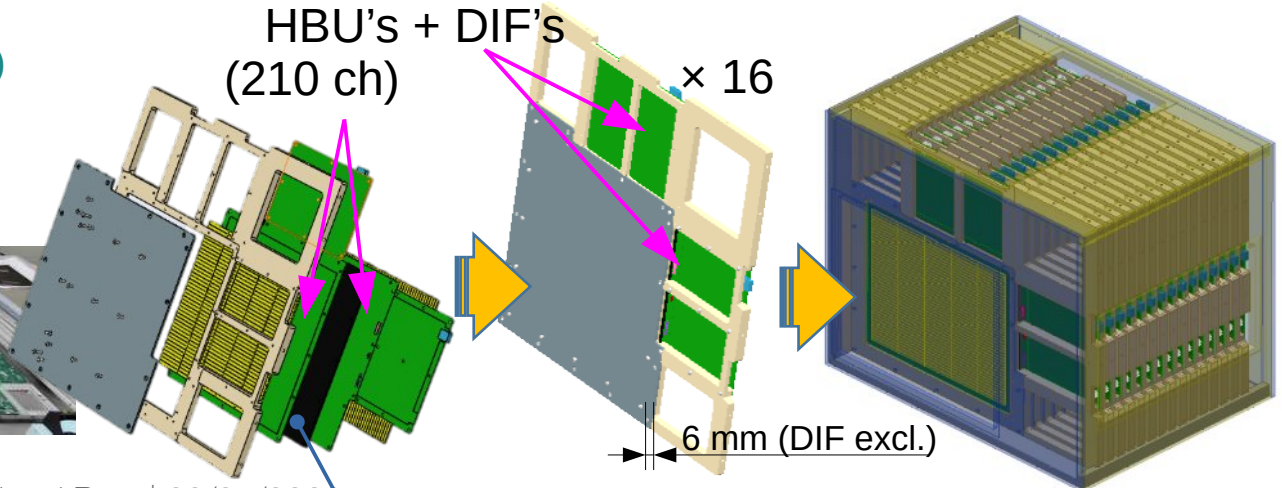
"Physical prototypes" (2005–11, 2013–15)

- Stack with 32 layers ready
 - aging test made (48h @ 50°C)
 - being assembled



Baseline SiPM
 Hamamatsu S12571-010P
 • size: 1mm × 1mm
 • pitch: 10 μm
 • number of pixels: 10K

× 30 10 μm & 15 μm SiPM
 × 2

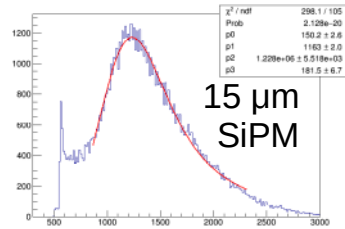
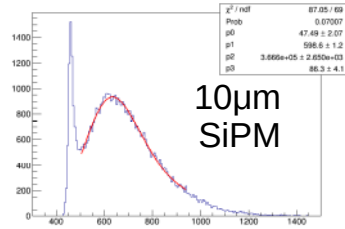
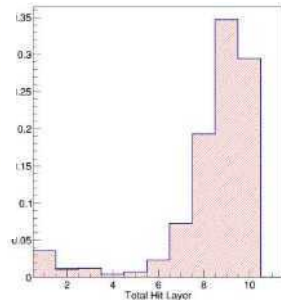
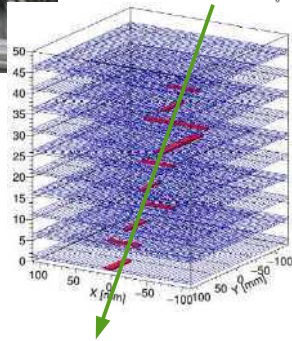
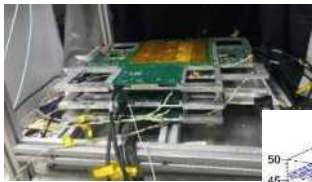


ScECAL: commissioning

Sr90 Source

- 25 ns shaping auto-trig
- Landau \otimes Gauss

Cosmics test

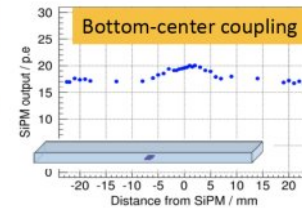
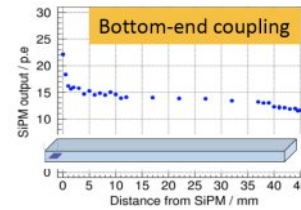
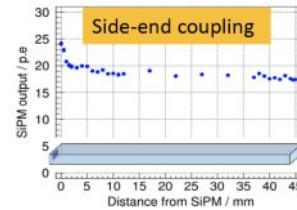


Beam tests

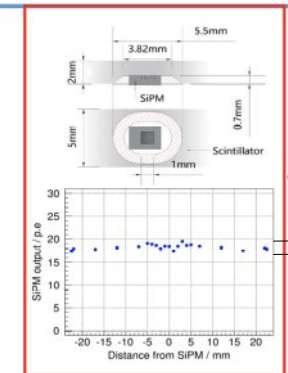
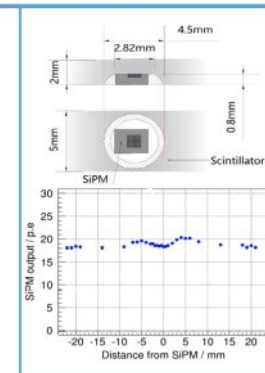
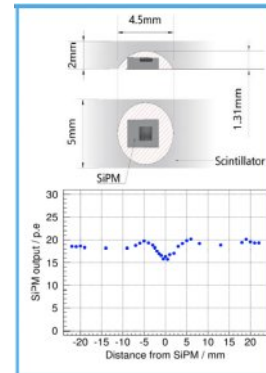
- DESY beginning of 2021 ... if travel is permitted

R&D:

- Scintillator – SiPM coupling
 - non-uniformity $\Rightarrow \sigma(E) \nearrow$
- SiPM position



- Groove form



4%

Scintillator AHCAL

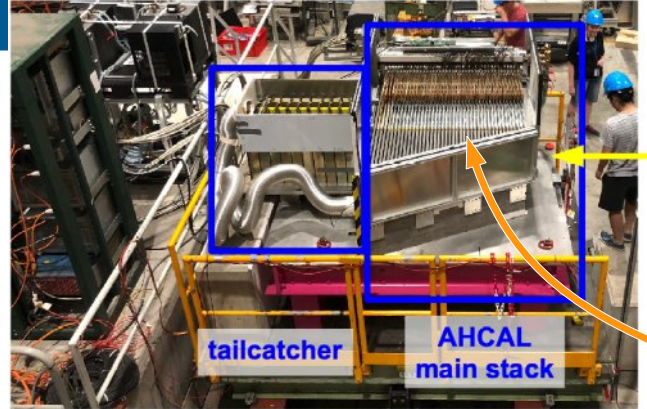
For ILC and CMS

- ILC with Omega SPIROC2e
 - HL-LHC will be Omega HGROCV3
- 3x3 cm², density ~ 55 cells / dm³

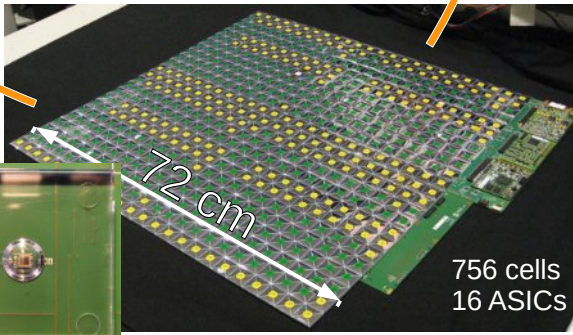
Technological prototype ≥ 2017

Physics prototype ~ 2006-11 (3x3 + 6x6 + 12x12 tiles)

- Uniform 3x3 cm² tiles (moulded) read by SiPM mounted on PCB
- 38 layers of 0,7x0,7 m², 22k cells
 - + additional layers of 6x6 cm²
- 2018: Stand alone tests and with CMS HGCAL
 - 4λ of stainless steel (1.7 cm x38)
- **Combined beam test with ECALs when ready**
- **Stand-alone with full W structure**



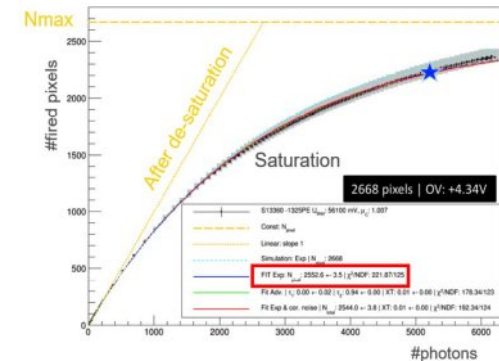
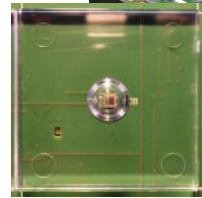
beam



Online corrections: on SiPM's:

⇒ EM Lin & Resol.

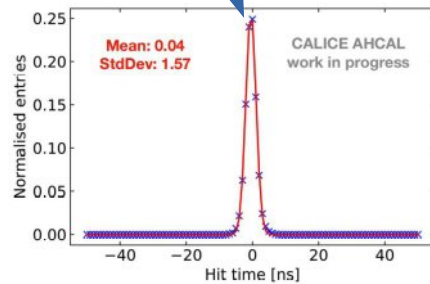
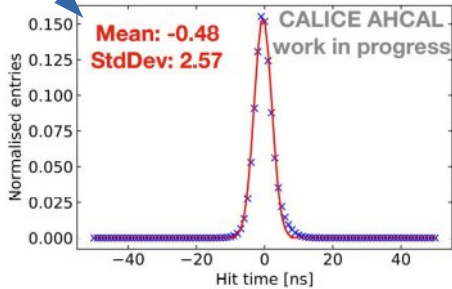
- Gain (Temperature, HV)
- Statistical saturation for $E_{hit} \geq 100$ mips ($N_{\gamma} \sim N_{pix}$)
 - Corrected for $E \leq 350$ mips



AHCAL analysis

New: Hit time correlation

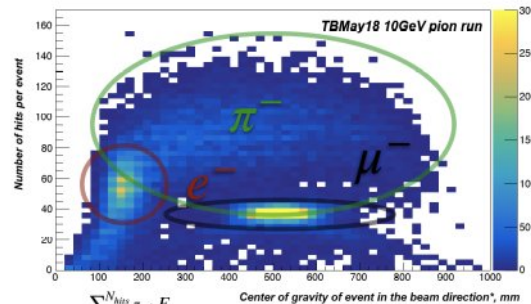
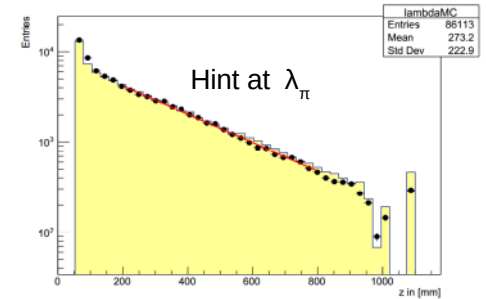
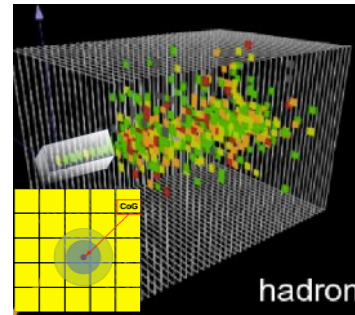
- Time profile from muons
 - SPIROC : double analog ramp → ADC
 - with clocks
- at 250kHz (beam test mode) : $\sigma \sim 2.6$ ns
- 5 MHz (ILC mode) : $\sigma \sim 1.6$ ns



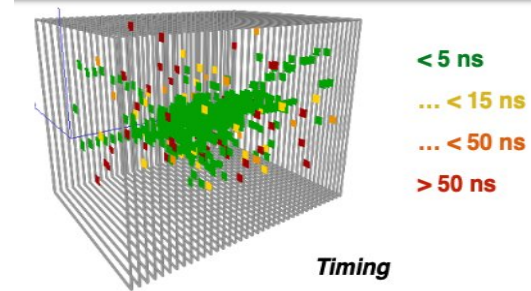
– Goal: 1 ns in ILC mode

High Level Analyses:

- Shower profiles & PFA tests (≥ 2011)
- Shower start, PID, f_{neutrons} (time)



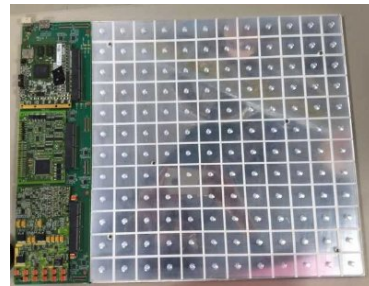
$$* z_{CoG} = \frac{\sum_{i=1}^{N_{Hits}} z_i \cdot E_i}{E_{sum}}$$



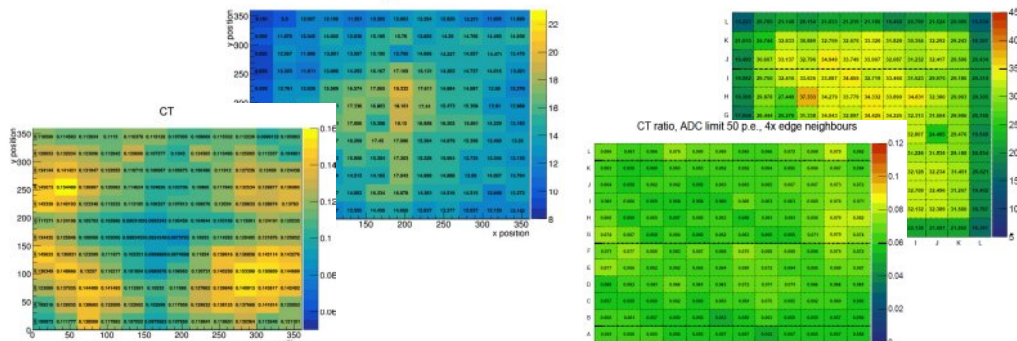
AHCAL developments

“MegaTiles” R&D:

- Single Scintillator tile with trenches of $3 \times 3 \text{ cm}^2$
- 2019 Beam test:
 - Light Yield, Mip resp, Optical Cross-talk
 - Larger Cross-Talk than in cosmics (mechanics)



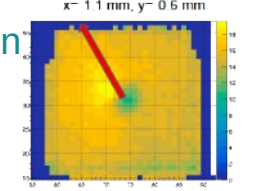
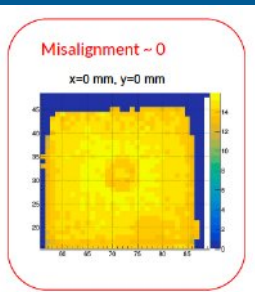
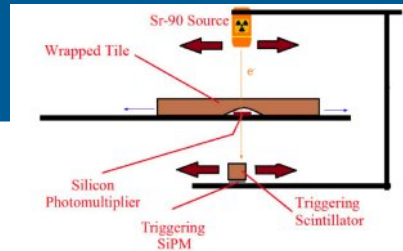
Light Yield & Cross-talk for 2 ≠ Sets of Mega-Tiles



Defects understood; best of both in next beam test (August)

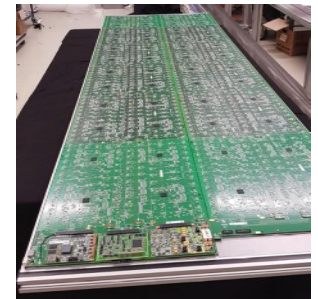
R&D

- Scintillators optimisation
 - Measurements ⇒ Realistic Simulation
- SiPM/MPPC evaluations
- ADC consumption (KLAUS Chip)



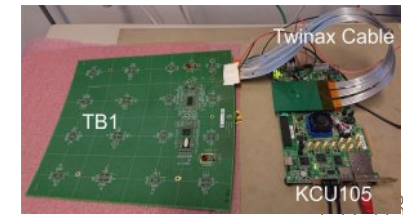
Long Layer

- 2×6 HBU's OK in lab...
 - Goals:
 - 3×6 HBU's (ILD)
 - ... in a test structure (absorbers)



CMS HGCAL:

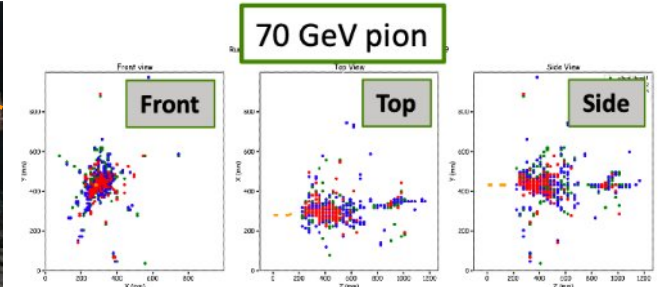
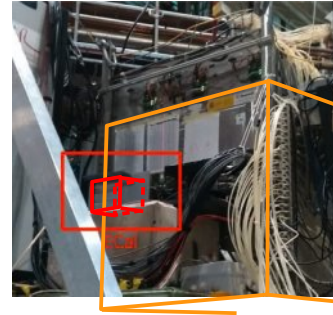
- 1st PCB test in beam in August



SDHCAL: Semi-Digital Gaseous HCAL

Technological prototype ≥ 2011

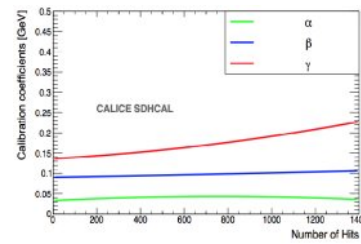
- Single and multi-gap thin GRPC's
- Cells of 1×1 cm², ρ = 380 cells/dm³
- Ωmega HARDROC2
- 48 layers of 1×1 m², 460k cells, 6λ_i (2 cm Stainless steel)



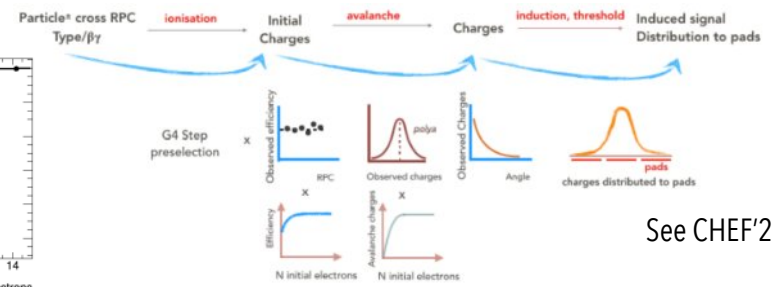
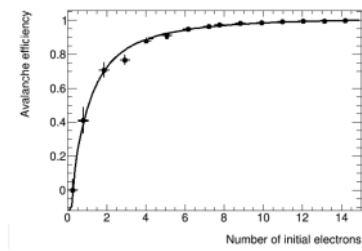
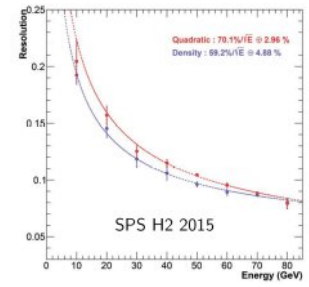
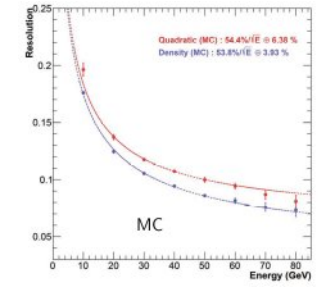
Semi-Digital calorimetry: 3 thresholds

- Uniformity: efficiency & multiplicity
- Threshold optimisations (typ. 1/2 mips, ~5, ~15 mips)
 - and calibration by scans
- Energy measurement:
 - Linearity & Resolution to single e, π, p
 - Simulation: **complex digitization**
 - Large number of overlapping effects in avalanches / readout / time
 - Now, reasonable ≤ 40 GeV e, π

$$E_{Quad} = \alpha (N_{tot}) N_1 + \beta (N_{tot}) N_2 + \gamma (N_{tot}) N_3$$



$$E_{Dens} = \alpha B_1 + \beta B_2 + \gamma B_3; B_i = \text{Neighbours} \geq \text{thr. } i$$



See CHEF'2019 for details

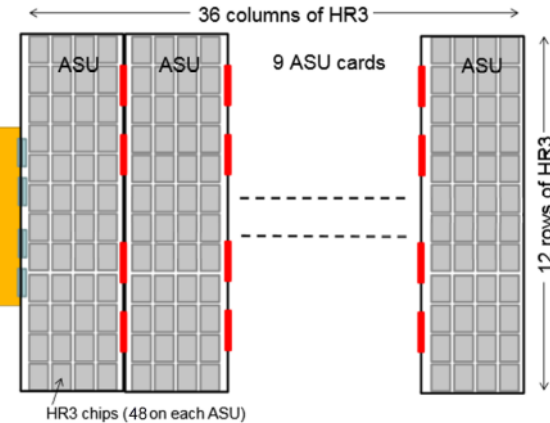
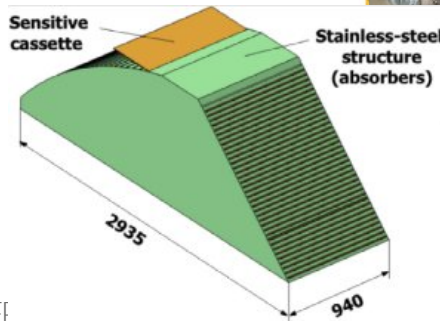
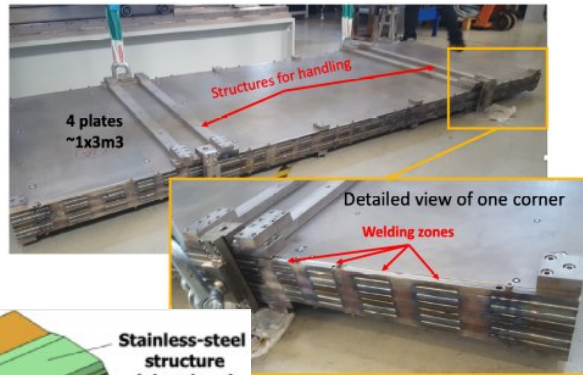
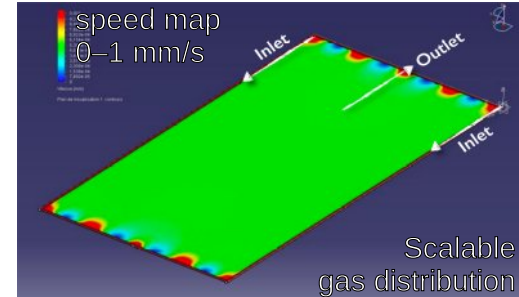
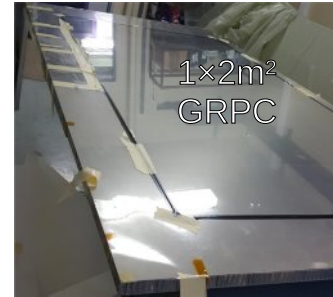
SDHCAL developments

Large cassettes: 1x1 m² → 3x1 m²:

- 432 ASICs HardRoc3: I2C, full zero-suppression, dynamic range ×3 (15 → 50pC)

Main goals:

- Sensors: Large uniform GRPC's
- Large & flat PCBs: 32×96 cm²
 - glued on single GRPC chamber
 - interconnections (in 3T field)
- Mechanical assembly
 - Electron Beam Welding



Timing:

Ωmega PETIROC ASIC (20 ps) jitter ⊕ Multi-gap GRPC (60 ps)

Take Home

New version of full technological prototypes getting ready for large BT campaign

- ⇒ Large knowledge base from previous prototypes & campaigns
- within ILC timeline (≤ 5 years of R&D)

Wealth of information, partly explored:

- Digital calorimetry
- in-shower software compensations
- new particle ID variables
- Timing in Calorimeters

Ideal ground for new analysis techniques (Multivariate Analyse, AI)

Many “small scale” R&D

- ⇒ Model of needed precision (Mechanics, Physics)

CALICE: 15 years of R&D

- have allowed some projects to get a boost
 - CMS HGICAL, Atlas HGTD
- Collaborative approach to realise and compare various ideas & solutions
 - Sharing of information & expertise
 - BT knowledge, DAQ, Simulation & Analysis Tools, ...
 - Started as ILC (as in caILCe)
 - no more directly experiment related Higgs factories, and beyond (FOCAL, CMS-HGICAL)
 - New Topics: timing in calorimeters, Dual Readout, ...
 - Session @ Collab meeting for Outreach.

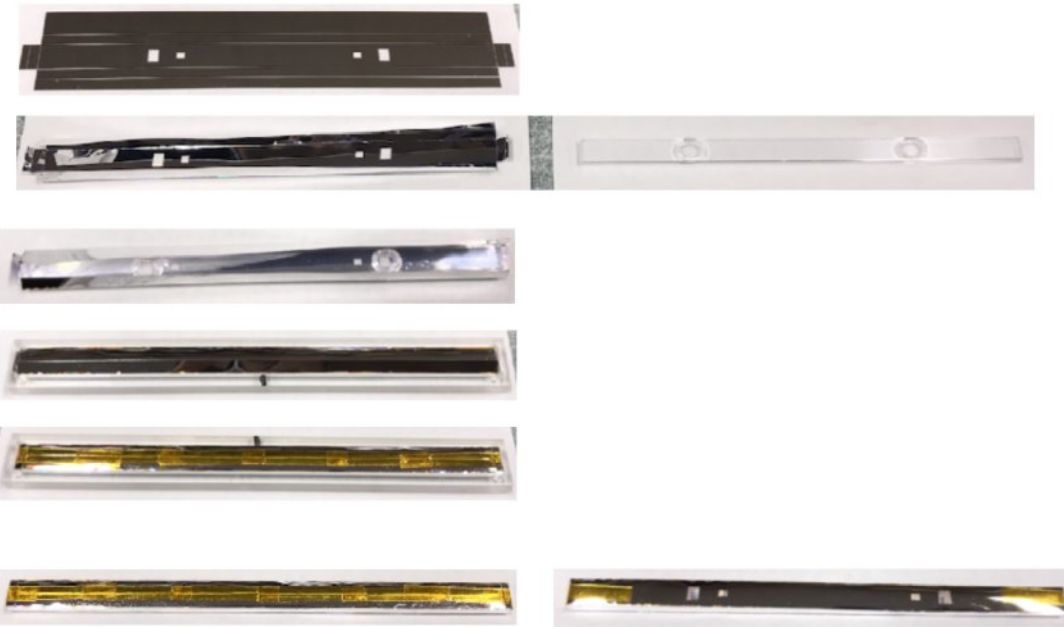
Vibrant and open community...

Extras

Scint-ECAL tile wrapping

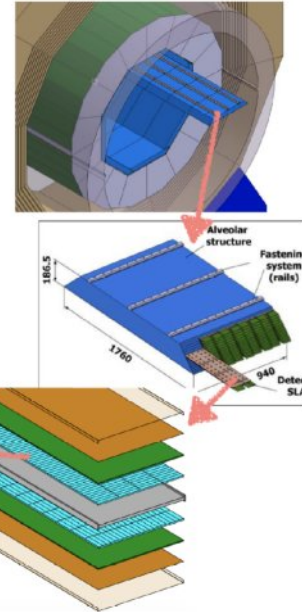
Reflector wrapping (90mm strip)

- Wrapping by hand with a help of jig



Sc-ECAL (reminder)

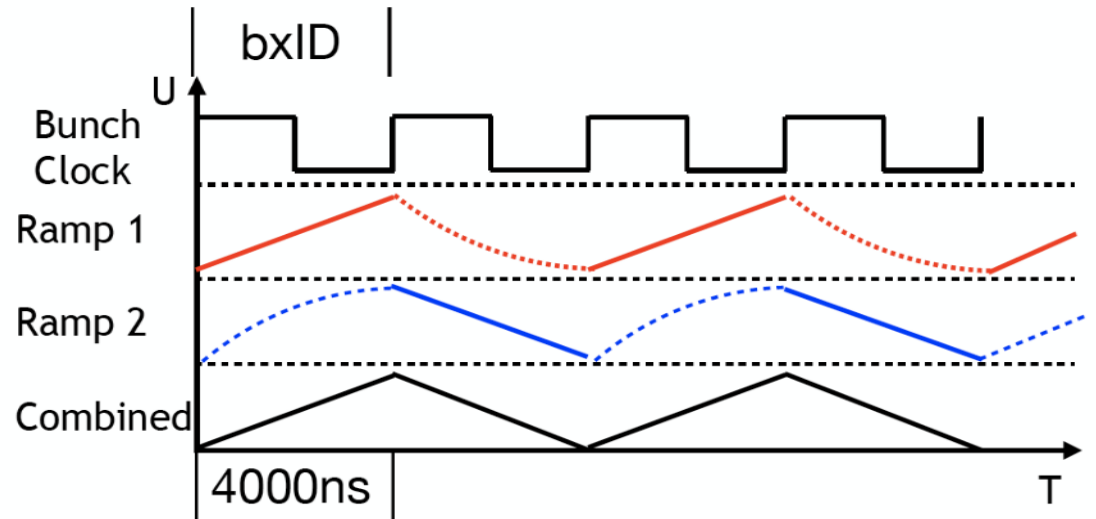
- Scintillator Electromagnetic CALorimeter (Sc-ECAL)
 - Technology option of EM calorimeter for ILD
- Based on scintillator strips readout by SiPM
 - $5 \times 45 \times 2$ mm scintillator strip
- Virtual segmentation : 5mm x 5mm with strips in x-y configuration
- Timing resolution < 1 ns
- Low cost



Time calibration (HW)

Time measurement with Spiroc2E: TDC
(time to digital converter)

1. Common external clock with $\sim 1\text{ns}$ bins
2. Ramp up voltage during one bunch crossing ID

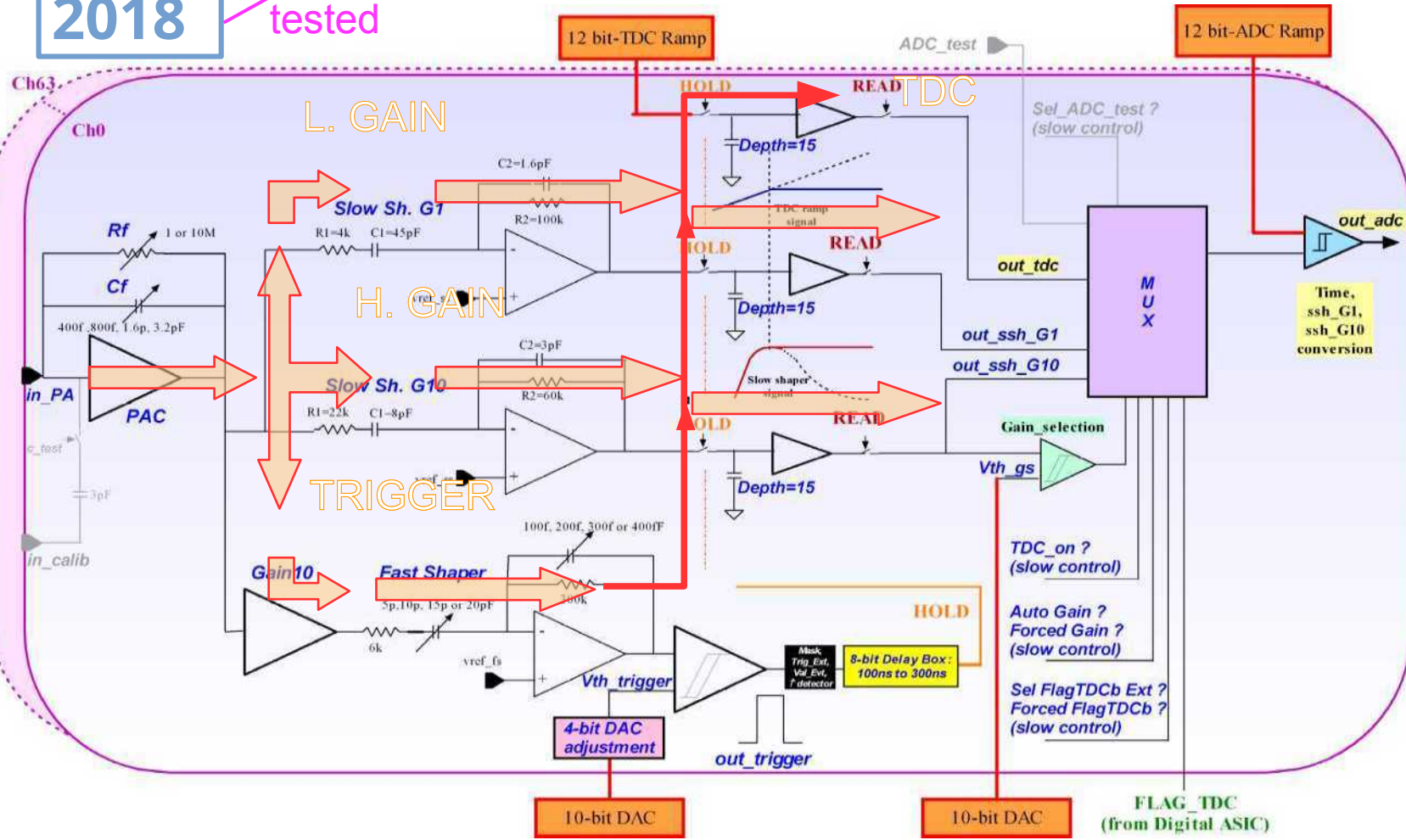


Lorenz Emberger (MPI. Munich)

SKIROC2 / 2A Analogue core

2018

tested



Similar to SiD Kpix

- 64 channels
- Preamp + 2 (auto)Gains + TDC (~1.4ns)
- Auto-triggered
 - per cell adj.
- 15 (x2) analogue memories
- Low consumption
 - 25 μ W/ch with 0.5% ILC-like duty cycle
- Power-pulsed

Not final chip (full 0-suppr.)